

National Semiconductor

January 2000

LM185-1.2/LM285-1.2/LM385-1.2 Micropower Voltage Reference Diode

General Description

The LM185-1.2/LM285-1.2/LM385-1.2 are micropower 2-terminal band-gap voltage regulator diodes. Operating over a 10 µA to 20 mA current range, they feature exceptionally low dynamic impedance and good temperature stability. On-chip trimming is used to provide tight voltage tolerance. Since the LM185-1.2 band-gap reference uses only transistors and resistors, low noise and good long term stability result.

Careful design of the LM185-1.2 has made the device exceptionally tolerant of capacitive loading, making it easy to use in almost any reference application. The wide dynamic operating range allows its use with widely varying supplies with excellent regulation.

The extremely low power drain of the LM185-1.2 makes it useful for micropower circuitry. This voltage reference can be used to make portable meters, regulators or general purpose analog circuitry with battery life approaching shelf life.

Further, the wide operating current allows it to replace older references with a tighter tolerance part.

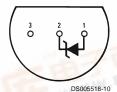
The LM185-1.2 is rated for operation over a -55°C to 125°C temperature range while the LM285-1.2 is rated -40°C to 85°C and the LM385-1.2 0°C to 70°C. The LM185-1.2/LM285-1.2 are available in a hermetic TO-46 package and the LM285-1.2/LM385-1.2 are also available in a low-cost TO-92 molded package, as well as SO and SOT-23. The LM185-1.2 is also available in a hermetic leadless chip carrier package.

Features

- ±4 mV (±0.3%) max. initial tolerance (A grade)
- Operating current of 10 µA to 20 mA
- 0.6Ω max dynamic impedance (A grade)
- Low temperature coefficient
- Low voltage reference 1.235V
- 2.5V device and adjustable device also available
- LM185-2.5 series and LM185 series, respectively

Connection Diagrams

T0-92 Plastic Package (Z)



Bottom View
Order Number LM285Z-1.2,
LM285BXZ-1.2, LM285BYZ-1.2
LM385Z-1.2, LM385BZ-1.2
LM385BXZ-1.2 or LM385BYZ-1.2
See NS Package Number Z03A

SOT23

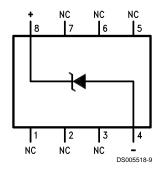
* Pin 3 is attached to the Die Attach Pad (DAP) and should be connected to Pin 2 or left floating.

Order Number LM385M3-1.2 See NS Package Number MA03B



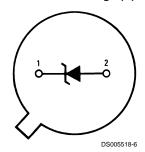
Connection Diagrams (Continued)

SO Package



Order Number LM285M-1.2, LM285BXM-1.2, LM285BYM-1.2 LM385M-1.2, LM385BM-1.2 LM385BXM-1.2 or LM385BYM-1.2 See NS Package Number M08A

TO-46 Metal Can Package (H)



Bottom View
Order Number LM185H-1.2, LM185H-1.2/883,
LM185BXH-1.2, LM185BYH-1.2
LM285H-1.2 or LM285BXH-1.2
See NS Package Number H02A

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

(Note 2)

Reverse Current 30 mA Forward Current 10 mA

Operating Temperature Range (Note 3)

 Storage Temperature -55°C to +150°C

Soldering Information

TO-92 package: 10 sec. 260°C TO-46 package:10 sec. 300°C

SO and SOT Pkg.

Vapor phase (60 sec.) 215°C Infrared (15 sec.) 220°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Electrical Characteristics (Note 4)

			LM1	85-1.2					
			LM185BX-1.2		LM385B-1.2				
			LM185BY-1.2		LM385BX-1.2		LM385-1.2		
			LM2	85-1.2	LM385BY-1.2				Units
Parameter	Conditions	Тур	LM285BX-1.2						(Limit)
			LM285BY-1.2						
			Tested	Design	Tested	Design	Tested	Design	
			Limit	Limit	Limit	Limit	Limit	Limit	
			(Notes	(Note 6)	(Note 5)	(Note 6)	(Note 5)	(Note 6)	
			5, 8)						
Reverse Breakdown	T _A = 25°C,	1.235	1.223		1.223		1.205		V(Min)
Voltage	10 μA ≤ I _R ≤ 20 mA		1.247		1.247		1.260		V(Max)
Minimum Operating		8	10	20	15	20	15	20	μA
Current	LM385M3-1.2						10	15	(Max)
Reverse Breakdown	10 μA ≤ I _R ≤ 1 mA		1	1.5	1	1.5	1	1.5	mV
Voltage Change									(Max)
with Current	1 mA ≤ I _R ≤ 20 mA		10	20	20	25	20	25	mV
									(Max)
Reverse Dynamic	I _R = 100 μA, f = 20 Hz	1							Ω
Impedance									
Wideband Noise	I _R = 100 μA,	60							μV
(rms)	10 Hz ≤ f ≤ 10 kHz								
Long Term Stability	I _R = 100 μA, T = 1000 Hr,	20							ppm
	$T_A = 25^{\circ}C \pm 0.1^{\circ}C$								
Average Temperature	I _R = 100 μA								
Coefficient (Note 7)	X Suffix		30		30				ppm/°C
	Y Suffix		50		50				ppm/°C
	All Others			150		150		150	ppm/°C
									(Max)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed.

Note 2: Refer to RETS185H-1.2 for military specifications.

Note 3: For elevated temperature operation, $T_{\hat{i}}$ max is:

LM185 150°C LM285 125°C LM385 100°C

Thermal Resistance	TO-92	TO-46	SO-8	SOT23
θ_{JA} (junction to ambient)	180°C/W (0.4" leads)	440°C/W	165°C/W	283°C/W
	170°C/W (0.125" leads)			
θ_{JC} (junction to case)	N/A	80°C/W	N/A	N/A

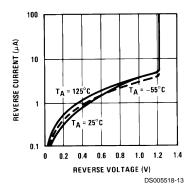
Note 4: Parameters identified with boldface type apply at temperature extremes. All other numbers apply at $T_A = T_J = 25^{\circ}C$.

Electrical Characteristics (Note 4) (Continued)

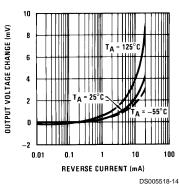
- Note 5: Guaranteed and 100% production tested.
- Note 6: Guaranteed, but not 100% production tested. These limits are not used to calculate average outgoing quality levels.
- Note 7: The average temperature coefficient is defined as the maximum deviation of reference voltage at all measured temperatures between the operating T_{MAX} and T_{MIN} , divided by T_{MAX} – T_{MIN} . The measured temperatures are –55°C, –40°C, 0°C, 25°C, 70°C, 85°C, 125°C.
- Note 8: A military RETS electrical specification is available on request.

Typical Performance Characteristics

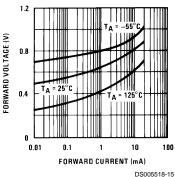
Reverse Characteristics



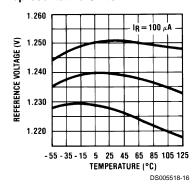
Reverse Characteristics



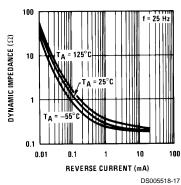
Forward Characteristics



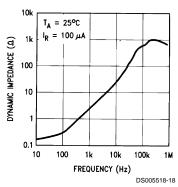
Temperature Drift of 3 Representative Units



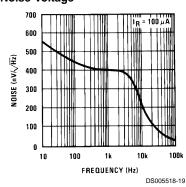
Reverse Dynamic Impedance



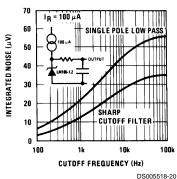
Reverse Dynamic Impedance



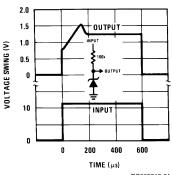
Noise Voltage



Filtered Output Noise



Response Time

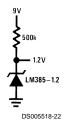


DS005518-21

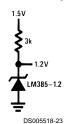
Typical Applications

Wide Input Range Reference VIN = 2.3V TO 30V LM334 4.3k OUT 1.24V

Micropower Reference from 9V Battery



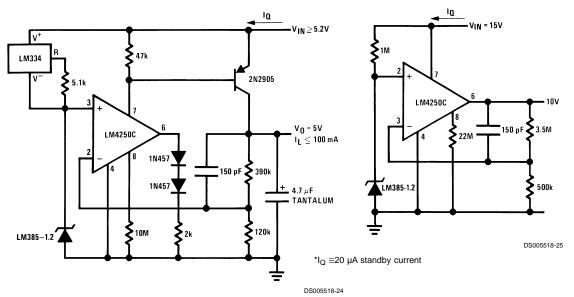
Reference from 1.5V Battery



Micropower* 5V Regulator

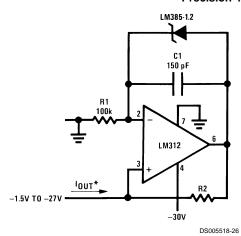
DS005518-8

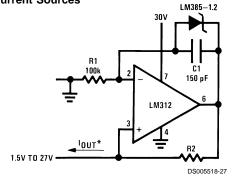
Micropower* 10V Reference



 $^*I_Q\cong 30~\mu A$

Precision 1 µA to 1 mA Current Sources



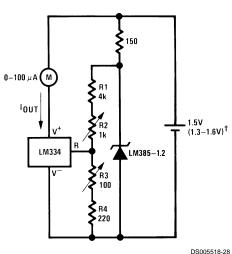


 $*I_{OUT} = \frac{1.23V}{R2}$

Typical Applications (Continued)

METER THERMOMETERS

0°C-100°C Thermometer



* 1.3 TO 1.6V [‡]

DS005518-29

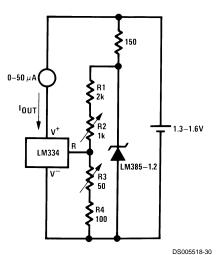
Lower Power Thermometer

*2N3638 or 2N2907 select for inverse H_{FE} \cong 5 †Select for operation at 1.3V \ddagger I $_Q$ \cong 600 μ A to 900 μ A

Calibration

- 1. Short LM385-1.2, adjust R3 for $I_{OUT}\text{=}$ temp at 1 $\mu\text{A}/^{\circ}\text{K}$
- 2. Remove short, adjust R2 for correct reading in centigrade $\dagger I_Q$ at 1.3V=500 μA I_Q at 1.6V=2.4 mA

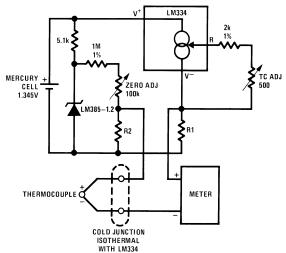
0°F-50°F Thermometer



Calibration

- 1. Short LM385-1.2, adjust R3 for $I_{\mbox{OUT}}\mbox{=}$ temp at 1.8 $\mbox{$\mu$A/$^{\circ}$K}$
- 2. Remove short, adjust R2 for correct reading in °F

Micropower Thermocouple Cold Junction Compensator



DS005518-31

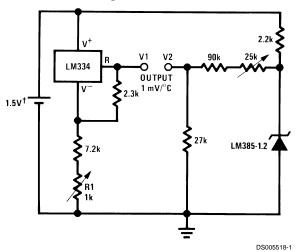
Adjustment Procedure

- Adjust TC ADJ pot until voltage across R1 equals Kelvin temperature multiplied by the thermocouple Seebeck coefficient.
- 2. Adjust zero ADJ pot until voltage across R2 equals the thermocouple Seebeck coefficient multiplied by 273.2.

Thermocouple Type	Seebeck Coefficient (µV/°C)	R1 R2 (Ω) (Ω)		Voltage Across R2 (mV)
J	52.3	523 1.24k	15.60	14.32
Т	42.8	432 1k	12.77	11.78
K	40.8	412 953Ω	12.17	11.17
S	6.4	63.4 150Ω	1.908	1.766
Typical supply curre	ent 50 µA			

Typical Applications (Continued)

Centigrade Thermometer

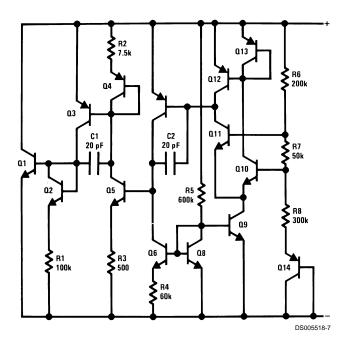


Calibration

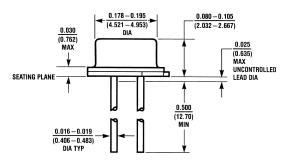
- 1. Adjust R1 so that V1 = temp at 1 mV/°K
- 2. Adjust V2 to 273.2 mV

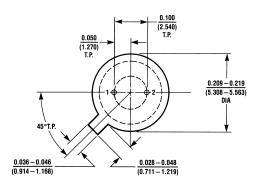
 $^{\dagger}I_{Q}$ for 1.3V to 1.6V battery voltage = 50 μA to 150 μA

Schematic Diagram



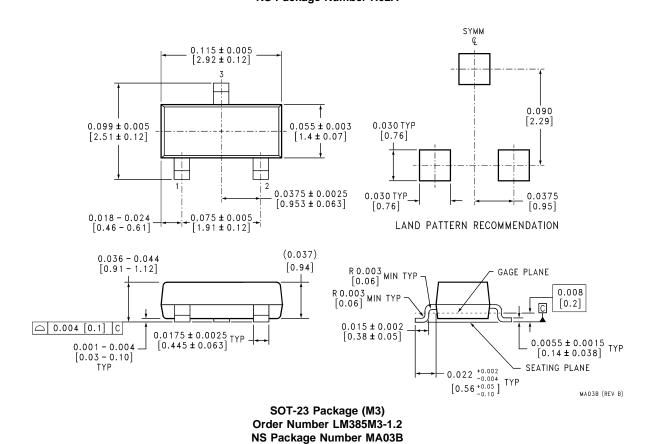
Physical Dimensions inches (millimeters) unless otherwise noted





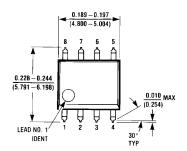
TO-46 Metal Can Package (H)
Order Number LM185H-1.2, LM185H-1.2/883, LM185BXH-1.2, LM185BYH-1.2, LM285H-1.2, or LM285BXH-1.2
NS Package Number H02A

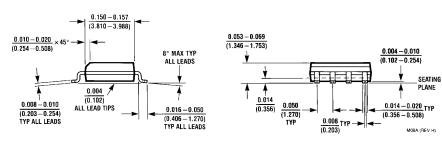
H02A (REV C)



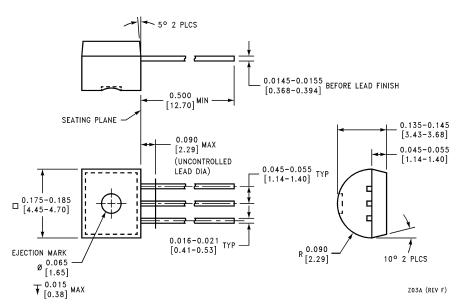
8

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





Small Outline (SO-8) Package
Order Number LM285M-1.2, LM285BXM-1.2, LM285BYM-1.2
LM385M-1.2, LM385BM-1.2, LM385BXM-1.2, LM385BYM-1.2
NS Package Number M08A



TO-92 Plastic Package (Z)
Order Number LM285Z-1.2, LM285BXZ-1.2
LM285BYZ-1.2, LM385Z-1.2, LM385BZ-1.2
LM385BXZ-1.2 or LM385BYZ-1.2
NS Package Number Z03A

Notes

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